

UNISONIC TECHNOLOGIES CO., LTD

2N50 **Preliminary Power MOSFET**

2A, 500V N-CHANNEL **POWER MOSFET**

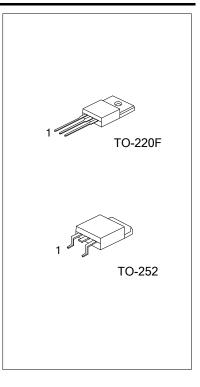
DESCRIPTION

The UTC 2N50 is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

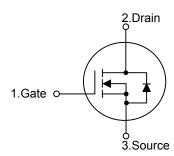
The UTC 2N50 is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

FEATURES

- * $R_{DS(ON)}$ = 4.9 Ω @ V_{GS} =10V
- * High Switching Speed
- * 100% Avalanche Tested



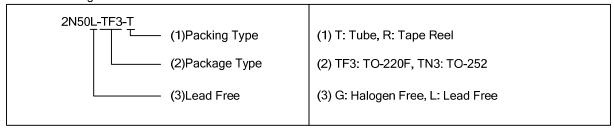
SYMBOL



ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking
Lead Free	Halogen Free	Package	1	2	3	Packing
2N50L-TF3-T	2N50G-TF3-T	TO-220F	G	D	S	Tube
2N50L-TN3-R	2N50G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



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■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT	
Drain-Source Voltage			V_{DSS}	500	V	
Gate-Source Voltage			V_{GSS}	±30	V	
Drain Current	Continuous (T _C =25°C)		I_D	2 (Note 3)	Α	
Diam Current	Pulsed (Note 2)		I _{DM}	8 (Note 3)	Α	
Avalanche Current (Note 2)			I _{AR}	2	Α	
Avalanaha Enavav	Single Pulsed		E _{AS}	82	mJ	
Avalanche Energy	Repetitive (Note 4)		E _{AR}	3.3	mJ	
Power Dissipation (T _C =25°C)		TO-220F		23	W	
		TO-252		50		
D 4 4 0500		TO-220F	P_{D}	0.18	141/90	
Derate above 25°C		TO-252		0.4	W/°C	
Junction Temperature			TJ	+150	°C	
Storage Temperature			T _{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. Drain current limited by maximum junction temperature
- 4. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

■ THERMAL DATA

PARAMETER	₹	SYMBOL	RATINGS	UNIT	
lunction to Ambient	TO-220F	θ_{JA}	62.5	°C/W	
Junction to Ambient	TO-252		110		
lunction to Coop	TO-220F	θ_{JC}	5.5	°C/W	
Junction to Case	TO-252		2.5	C/VV	

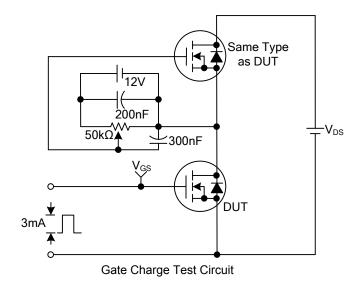
■ **ELECTRICAL CHARACTERISTICS** (T_C=25°C, unless otherwise noted)

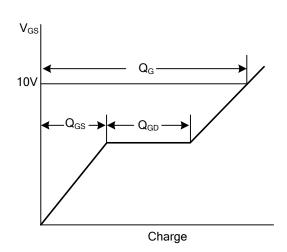
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT				
OFF CHARACTERISTICS										
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	500			V				
Drain-Source Leakage Current	I _{DSS}	V _{DS} =500V, V _{GS} =0V			25	μA				
Cata Source Leakage Current Forward	I _{GSS}	V_{GS} =+30V, V_{DS} =0V			+100	nA				
Gate- Source Leakage Current Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA				
ON CHARACTERISTICS										
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0		4.0	V				
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1A		3.9	4.9	Ω				
DYNAMIC PARAMETERS										
Input Capacitance	C _{ISS}			236		pF				
Output Capacitance	Coss	V_{GS} =0V, V_{DS} =25V, f=1.0MHz		40		pF				
Reverse Transfer Capacitance	C _{RSS}			22		pF				
SWITCHING PARAMETERS										
Total Gate Charge	Q_{G}	V _{GS} =10V, V _{DS} =400V, I _D =2A		20	25	nC				
Gate to Source Charge	Q_GS	-(Note 1, 2)		2	3	nC				
Gate to Drain Charge	Q_GD	(Note 1, 2)		12	15	nC				
Turn-ON Delay Time	$t_{D(ON)}$			10		ns				
Rise Time	t _R	V_{DD} =250V, I_{D} =2A, R_{G} =25 Ω (Note 1, 2)		20		ns				
Turn-OFF Delay Time	t _{D(OFF)}			60		ns				
Fall-Time	t _F			20		ns				
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS										
Maximum Body-Diode Continuous Current	Is				2	Α				
Maximum Body-Diode Pulsed Current	I _{SM}				8	Α				
Drain-Source Diode Forward Voltage	V _{SD}	I _S =2A, V _{GS} =0V			1.2	V				
Body Diode Reverse Recovery Time	t _{RR}	I_S =2A, V_{GS} =0V, dI_F/dt =100A/ μ s		300		ns				
Body Diode Reverse Recovery Charge	Q_{RR}	(Note 1)		2.1		μC				

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

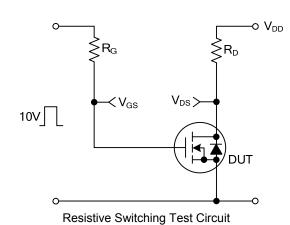
^{2.} Essentially independent of operating temperature

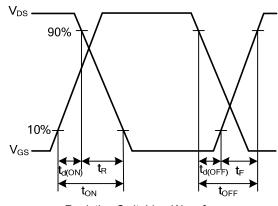
■ TEST CIRCUITS AND WAVEFORMS



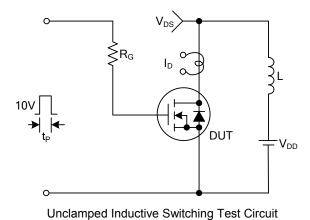


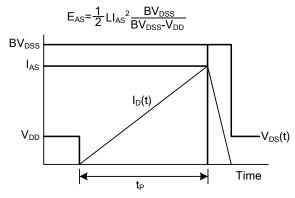
Gate Charge Waveforms





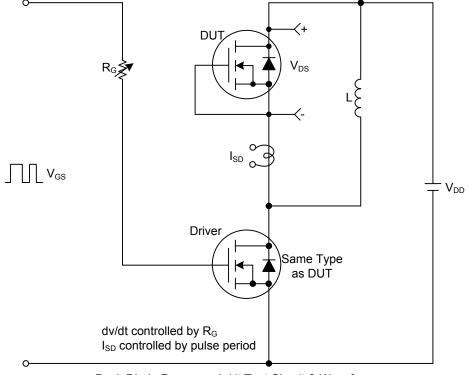
Resistive Switching Waveforms



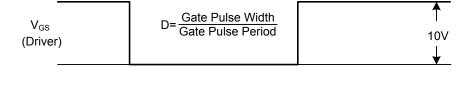


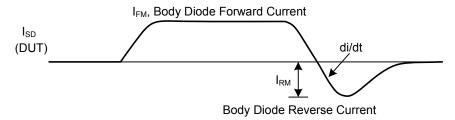
Unclamped Inductive Switching Waveforms

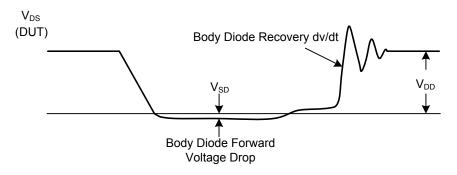
■ TEST CIRCUITS AND WAVEFORMS(Cont.)



Peak Diode Recovery dv/dt Test Circuit & Waveforms







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